

RKD750KN

Silicon Schottky Barrier Diode for Detector

REJ03G1359-0100

Rev.1.00

May 15, 2006

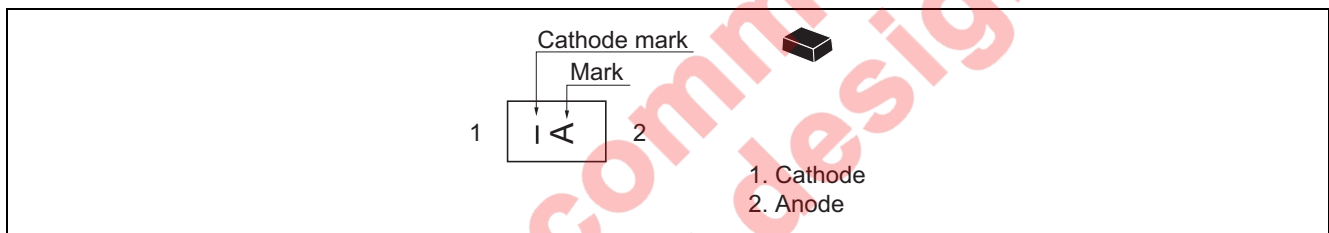
Features

- Low forward voltage, Low capacitance and High detection sensitivity.
- Ultra small leadless Package (0805type; the use of an undersurface electrode structure) for use in compact and products.

Ordering Information

Type No.	Laser Mark	Package Name	Package Code
RKD750KN	A	MP8	PXSN0002ZA-A

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V _R	2	V
Average rectified current	I _O	5	mA
Junction temperature	T _j	125	°C
Storage temperature	T _{stg}	-55 to +125	°C

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Forward voltage	V _{F1}	—	—	0.15	V	I _F = 0.1 mA
	V _{F2}	—	—	0.27		I _F = 1 mA
Capacitance	C	—	0.3	—	pF	V _R = 0.5 V, f = 1 MHz
ESD-Capability *1	—	10	—	—	V	C = 200 pF, R _L = 0 Ω, Both forward and reverse direction 1 pulse.

Notes: 1. Failure criterion ; I_R ≥ 100 μA at V_R = 0.5 V

2. Please do not use the soldering iron due to avoid high stress to the MP8 package.

Not recommended for new design

Main Characteristic

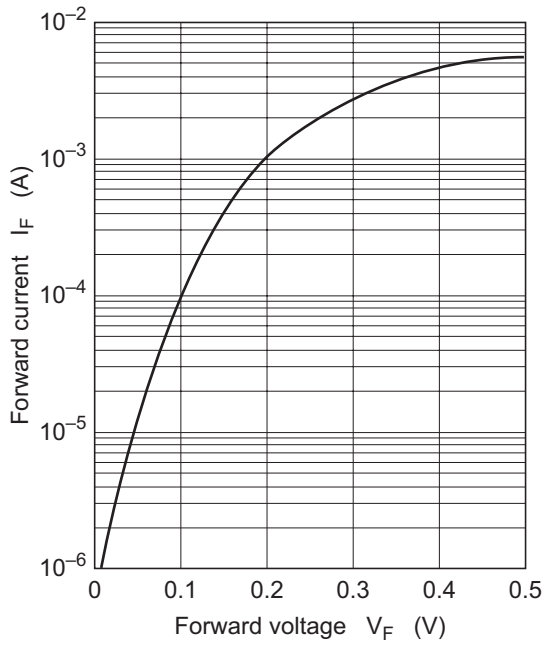


Fig.1 Forward current vs. Forward voltage

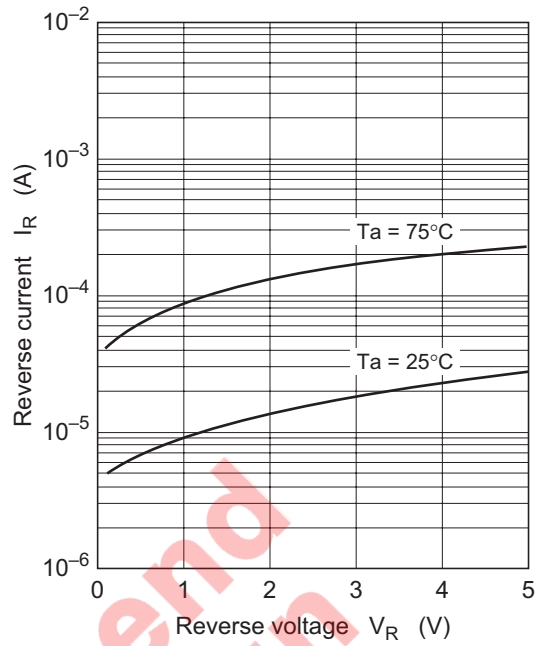


Fig.2 Reverse current vs. Reverse voltage

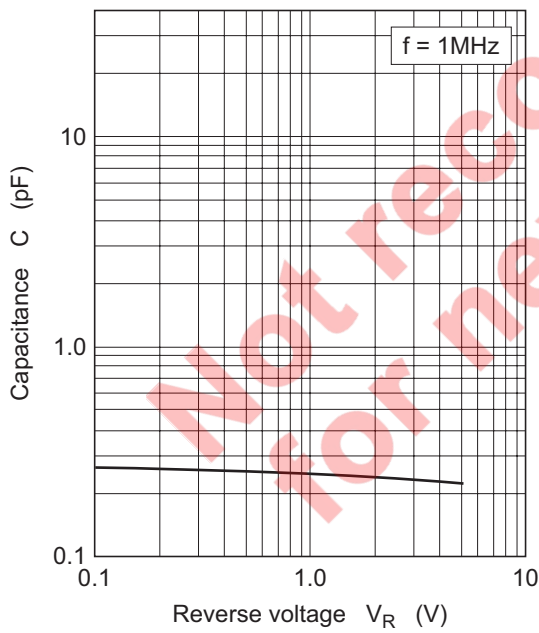
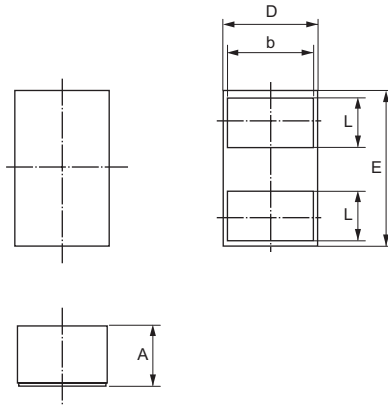


Fig.3 Capacitance vs. Reverse voltage

Package Dimensions

Package Name MP8	JEITA Package Code —	RENESAS Code PXSNO002ZA-A	Previous Code MP8V	MASS[Typ.] 0.00029g
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Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	0.27	0.30	0.33
b	0.38	0.40	0.42
D	0.47	0.50	0.53
E	0.77	0.80	0.83
L	0.23	0.25	0.27

Not recommend for new design

Keep safety first in your circuit designs!

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